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Electromagnetic compatibility (EMC) –

Part 1-5:
General –
High power electromagnetic (HPEM) effects on civil systems

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CONTENTS

FOREWORD 4
INTRODUCTION 6

1 Scope 7
2 Normative references 7
3 Terms and definitions 8
4 General introduction 12
4.1 Past experience with HPEM effects on systems 13
4.2 General EM protection techniques as applied to civil systems 14
5 Classification of HPEM environments 15
5.1 Radiated and conducted HPEM environments 17
5.2 Narrowband (CW) waveform 17
5.3 Ultrawideband/short pulse transient environment 19
5.4 Repetitive excitations 20
6 HPEM effects on systems 21
6.1 Topological representation of the system 21
6.2 Examples of HPEM effects on electronic systems and components 24
6.3 Component/subsystem burnout and permanent damage 26
6.4 Logic upset or service interruption 34
7 HPEM protection concepts 34
7.1 Strategy for selecting immunity levels 34
7.2 Overview of HPEM protection techniques 35
7.3 Realisation of HPEM protection 35

Bibliography 41

Figure 1 – Illustration of the spectral content of HPM and UWB signals, together with other EM signals 16
Figure 2 – Plot of a normalised Gaussian modulated sine wave, serving as a simple representation of a narrowband HPEM waveform 18
Figure 3 – Illustration of a wideband transient HPEM waveform together with its spectral magnitude 19
Figure 4 – Illustration of a repetitive waveform of pulses similar to that of Figure 2 20
Figure 5 – Simplified illustration of a hypothetical facility excited by an external electromagnetic field 22
Figure 6 – The topological diagram for the simple system shown in Figure 5 23
Figure 7 – General interaction sequence diagram for the facility of Figure 5 23
Figure 8 – Example of measured susceptibility thresholds in a DM74LS00N [TTL] quad 2-input NAND gate as a function of frequency, illustrating increased susceptibility thresholds at higher frequencies 27
Figure 9 – Example of damage caused by the telecom pulse generator due to a single shot of 4,5 kV 29
Figure 10 – Description of conducted disturbance injection experiment 32
Figure 11 – Illustration of the deliberate and inadvertent penetrations into the hypothetical system of Figure 5 36

Figure 12 – Example of a hypothetical deliberate coupling path into a system.....37
Figure 13 – Insertion of a protective device in the deliberate coupling path to provide EM protection against out-of-band disturbances.....38
Figure 14 – Illustration of typical HPEM inadvertent penetration protection methods.....39

Table 1 – Description of PCs tested, the environment and effects (after LoVetri).....24
Table 2 – HPEM effects on an automobile as a function of range and source power (Based on measured data from Bäckström).....25
Table 3 – Summary of results of testing power and data ports with the telecom and CWG pulse generators.....28
Table 4 – Results of injecting EFT pulses on an AppleTalk cable with the number of upsets/number of test sequences indicated 30
Table 5 – Results of injecting EFT pulses on a 10Base-T cable with the number of upsets/number of test sequences indicated.....30
Table 6 – Results of injecting EFT pulses on a 10Base-2 cable with the number of upsets/number of test sequences indicated.....31

INTERNATIONAL ELECTROTECHNICAL COMMISSION

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ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 1-5: General – High power electromagnetic (HPEM) effects on civil systems

FOREWORD

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IEC 61000-1-5, which is a technical report, has been prepared by subcommittee 77C: High power transient phenomena, of IEC technical committee 77: Electromagnetic compatibility. This document has the status of a Basic EMC Publication in accordance with IEC Guide 107, *Electromagnetic compatibility – Guide to the drafting of electromagnetic compatibility publications*.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
77C/146/DTR	77C/152/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

INTRODUCTION

IEC 61000 is published in separate parts according to the following structure:

Part 1: General

General considerations (introduction, fundamental principles)

Definitions, terminology

Part 2: Environment

Description of the environment

Classification of the environment

Compatibility levels

Part 3: Limits

Emission limits

Immunity limits (in so far as they do not fall under the responsibility of the product committees)

Part 4: Testing and measurement techniques

Measurement techniques

Testing techniques

Part 5: Installation and mitigation guidelines

Installation guidelines

Mitigation methods and devices

Part 6: Generic standards

Part 9: Miscellaneous

Each part is further subdivided into several parts and published either as International Standards or as technical specifications or technical reports, some of which have already been published as sections. Others will be published with the part number followed by a dash and a second number identifying the subdivision (example: 61000-6-1).

ELECTROMAGNETIC COMPATIBILITY (EMC) –

Part 1-5: General – High power electromagnetic (HPEM) effects on civil systems

1 Scope

This part of IEC 61000 is a technical report that provides background material describing the motivation for developing IEC standards on the effects of high power electromagnetic (HPEM) fields, currents and voltages on civil systems. In the light of newly emerging transient antenna technology and the increasing use of digital electronics, the possibility of equipment being upset or damaged by these environments is of concern. This document begins with a general introduction to this subject and a listing of the pertinent definitions used. Following these clauses, the HPEM environments that are of concern are described and a discussion of the various effects that these environments can induce in civil systems is presented. Finally, techniques used to protect systems against these environments are summarised. More detailed information will be provided in separate documents in this 61000 series.

2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies. Members of IEC and ISO maintain registers of currently valid International Standards.

IEC 60050-161, *International Electrotechnical Vocabulary (IEV) – Chapter 161: Electromagnetic compatibility*

IEC 61000-2-13, *Electromagnetic compatibility (EMC) – Part 2-13: Environment – High-power electromagnetic (HPEM) environments – Radiated and conducted* [1]

IEC 61000-4-4, *Electromagnetic compatibility (EMC) – Part 4-4: Testing and measurement techniques – Electrical fast transient/burst immunity test*

IEC 61000-4-5, *Electromagnetic compatibility (EMC) – Part 4: Testing and measurement techniques – Section 5: Surge immunity test* [2]
Amendment 1 (2000)

IEC 61000-5-3, *Electromagnetic compatibility (EMC) – Part 5-3: Installation and mitigation guidelines – HEMP protection concepts*

IEC 61000-5-6, *Electromagnetic compatibility (EMC) – Part 5-6: Installation and mitigation guidelines – Mitigation of external EM influences*

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[1] To be published.

[2] A consolidated edition 1.1 exists comprising IEC 61000-4-5:1995 and its Amendment 1 (2000).